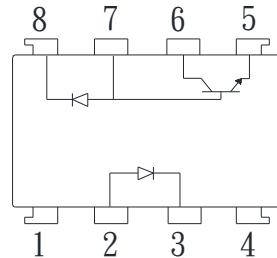


### ● Description

The KPC6N136 series consist of an LED optically coupled to an OPIC chip. It is a high-speed digital output type photocoupler designed specifically for low circuit current. And it is packaged in a 8 pin DIP package and available in wide-lead spacing and SMD option.

### ● Schematic



- |            |                   |
|------------|-------------------|
| 1. N.C.    | 5. GND            |
| 2. Anode   | 6. Vo             |
| 3. Cathode | 7. V <sub>B</sub> |
| 4. N.C.    | 8. Vcc            |

### ● Features

1. Pb free and RoHS compliant
2. High speed response  $t_{PHL}, t_{PLH}$  ( Max. 0.8us at  $R_L=1.9K\Omega$  )
3. High common mode rejection voltage ( CM<sub>H</sub> : TYP. 1KV/us )
4. Standard dual-in-line package
5. MSL class 1
6. Agency Approvals:
  - UL Approved (No. E169586): UL1577
  - c-UL Approved (No. E169586)
  - FIMKO Approved: EN60065, EN60950

### ● Applications

- Computers, measuring instruments, control equipment
- High speed line receivers, high speed logic
- Telephone sets
- Signal transmission between circuits of different potentials and impedances



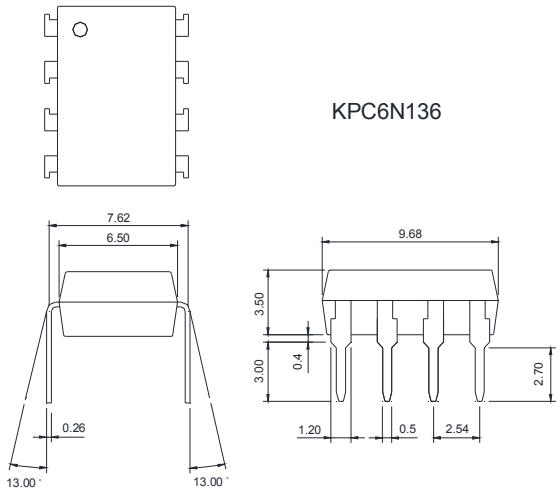
# KPC6N136 Series

## 8PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

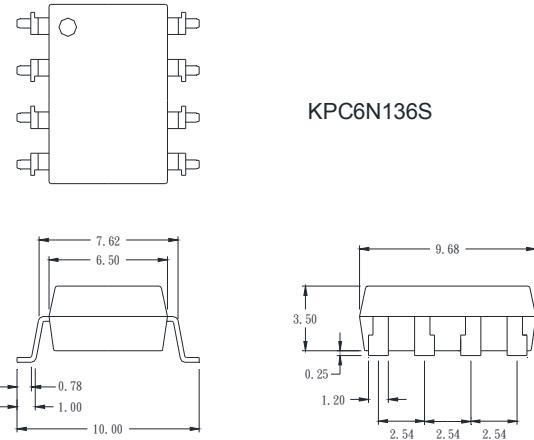
### ● Outside Dimension

Unit : mm

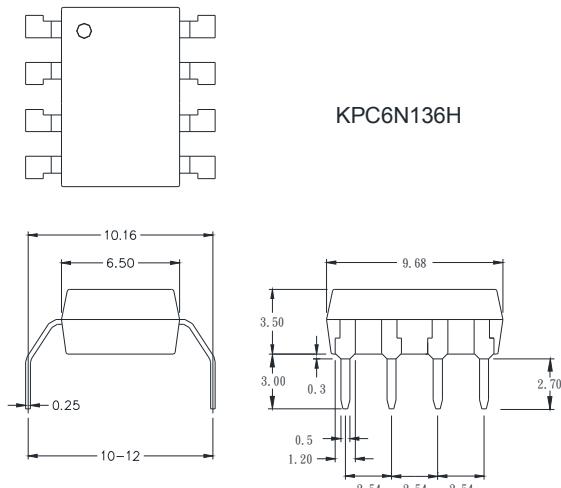
1.Dual-in-line type



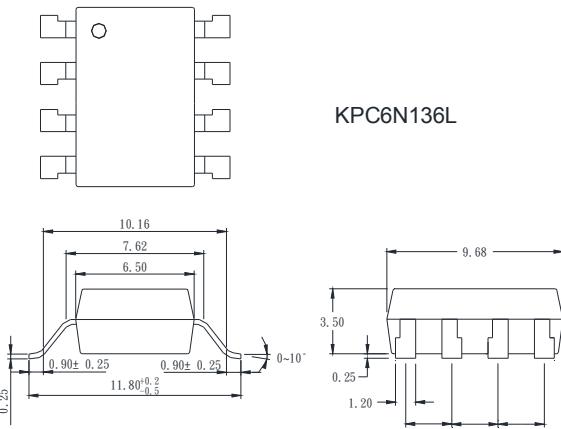
2.Surface mount type



3.Long creepage distance type

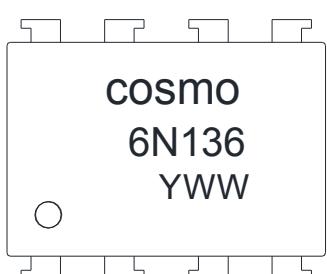


4.Long creepage distance  
for surface mount type



TOLERANCE: ±0.2mm

### ● Device Marking



#### Notes:

cosmo  
6N136  
YWW

Y: Year code / WW: Week code



# KPC6N136 Series

8PIN HIGH-SPEED OUTPUT  
PHOTOCOUPLER

## Absolute Maximum Ratings

(Ta = 25°C)

Parameter	Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	25 mA
	*1 Peak forward current	I <sub>F</sub>	50 mA
	*2 Peak transient forward current	I <sub>FM</sub>	1 A
	Reverse voltage	V <sub>R</sub>	5 V
Output	Power dissipation	P	45 mW
	Supply voltage	V <sub>CC</sub>	-0.5 to 15 V
	Output voltage	V <sub>O</sub>	-0.5 to 15 V
	Emitter-base reverse with stand voltage ( Pin5 to 7 )	V <sub>EBO</sub>	5 V
	Average output current	I <sub>O</sub>	8 mA
	Peak output current	I <sub>OP</sub>	16 mA
	Base current ( Pin7 )	I <sub>B</sub>	5 mA
	Power dissipation	P <sub>O</sub>	100 mW
	*3 Isolation voltage 1 minute	V <sub>iso</sub>	5000 V
	Operating temperature	T <sub>opr</sub>	-55 to +100 °C
	Storage temperature	T <sub>stg</sub>	-55 to +125 °C
	*4 Soldering temperature 10 seconds	T <sub>sol</sub>	260 °C

\*1 50% duty cycle, Pulse width : 1mS

Decreases at the rate of 1.6mA/°C if the external temperature is 70°C or more.

\*2 Pulse width  $\leq$  1uS, 300pulse/sec

\*3 40 to 60% RH, AC for 1 minute

\*4 For 10 seconds

## Electrical Characteristics

(Ta = 25°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
*5 Current transfer ratio	CTR(1)	Ta=25°C, I <sub>F</sub> =16mA V <sub>O</sub> =0.4V, V <sub>CC</sub> =4.5V	19	40	-	%
	CTR(2)	I <sub>F</sub> =16mA V <sub>O</sub> =0.5V, V <sub>CC</sub> =4.5V	15	43	-	%
Logic ( 0 ) output voltage	V <sub>OL</sub>	*6 V <sub>CC</sub> =4.5V, I <sub>F</sub> =16mA	-	0.1	0.4	V
Logic ( 1 ) output current	I <sub>OH(1)</sub>	Ta=25°C, I <sub>F</sub> =0 V <sub>O</sub> =V <sub>CC</sub> =5.5V	-	3.0	500	nA
	I <sub>OH(2)</sub>	Ta=25°C, I <sub>F</sub> =0 V <sub>O</sub> =V <sub>CC</sub> =15V	-	0.01	1.0	uA
	I <sub>OH(3)</sub>	V <sub>CC</sub> =V <sub>O</sub> =15V, I <sub>F</sub> =0	-	-	50	uA
Logic ( 0 ) supply current	I <sub>CCL</sub>	I <sub>F</sub> =16mA V <sub>O</sub> =open, V <sub>CC</sub> =15V	-	200	-	uA
Logic ( 1 ) supply current	I <sub>CCH(1)</sub>	Ta=25°C, I <sub>O</sub> =0 V <sub>F</sub> =open, V <sub>CC</sub> =15V	-	0.02	1.0	uA
	I <sub>CCH(2)</sub>	I <sub>O</sub> =0 V <sub>O</sub> =open, V <sub>CC</sub> =15V	-	-	2.0	uA
Input forward voltage	V <sub>F</sub>	Ta=25°C, I <sub>F</sub> =16mA	-	1.7	1.95	V
Input forward voltage temperature coefficient	△V <sub>F</sub> /△Ta	I <sub>F</sub> =16mA	-	-1.9	-	mV/°C
Input reverse voltage	BV <sub>R</sub>	Ta=25°C, I <sub>R</sub> =10uA	5.0	-	-	V
Input capacitance	C <sub>IN</sub>	V <sub>F</sub> =0, f=1MHz	-	60	-	pF
*7 Leak current ( input-output )	I <sub>I-O</sub>	Ta=25°C, 45%RH V <sub>I-O</sub> =3KVDC, t=5s	-	-	1.0	uA
*7 Isolation resistance ( input-output )	R <sub>I-O</sub>	V <sub>I-O</sub> =500VDC	-	10 <sup>12</sup>	-	Ω
*7 Capacitance ( input-output )	C <sub>I-O</sub>	f=1MHz	-	0.6	-	pF
Transistor current amplification factor	h <sub>FE</sub>	V <sub>O</sub> =5V, I <sub>O</sub> =3mA	-	70	-	

\*5 Current transfer ratio is the ratio of input current and output current expressed in %

\*6 I<sub>O</sub>=2.4mA

\*7 Measured as 2-pin element ( Short 1, 2, 3, 4 and 5, 6, 7, 8 )

**● Switching Characteristics**
 $(Ta=25^\circ\text{C}, V_{CC}=5\text{V}, I_F=16\text{mA} \text{ Ta} = 25^\circ\text{C})$ 

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
*8 Propagation delay time *9 Output (1) → (0)	$t_{PHL}$	$R_L=1.9\text{K}\Omega$	-	0.3	0.8	$\mu\text{s}$
*8 Propagation delay time *9 Output (0) → (1)	$t_{PLH}$	$R_L=1.9\text{K}\Omega$	-	0.3	0.8	$\mu\text{s}$
*10 Instantaneous common mode rejection voltage *11 "Output (1)"	$CM_H$	$I_F=0, V_{CM}=10\text{V}_{P-P}$	-	1000	-	$\text{V}/\mu\text{s}$
*10 Instantaneous common mode rejection voltage *11 "Output (0)"	$CM_L$	$I_F=16\text{mA}, V_{CM}=10\text{V}_{P-P}$	-	-1000	-	$\text{V}/\mu\text{s}$
*12 Bandwidth	BW	$R_L=100\Omega$	-	2.0	-	MHz

\*8  $R_L=1.9\text{K}\Omega$  is equivalent to one LSTTL and 5.6KΩ pull-up resistor.

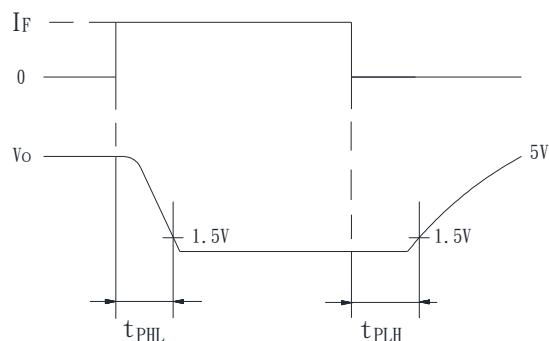
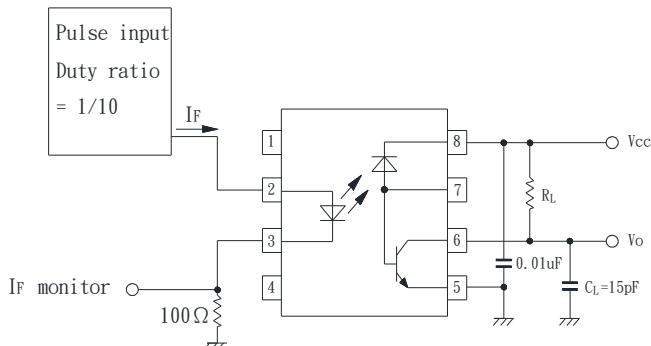
\*10 Instantaneous common mode rejection voltage "output (1)" represents a common mode voltage variation that can hold the output above (1) level ( $V_o > 2.0\text{V}$ )

Instantaneous common mode rejection voltage "output (0)" represents

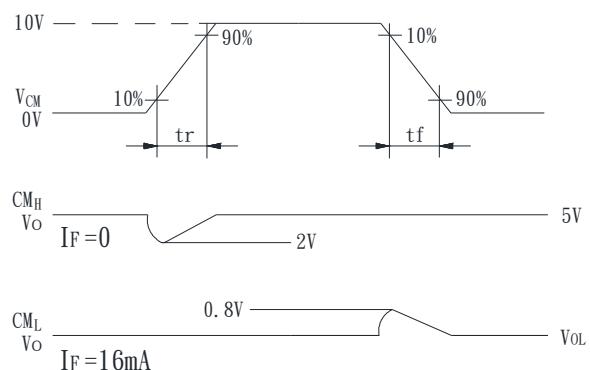
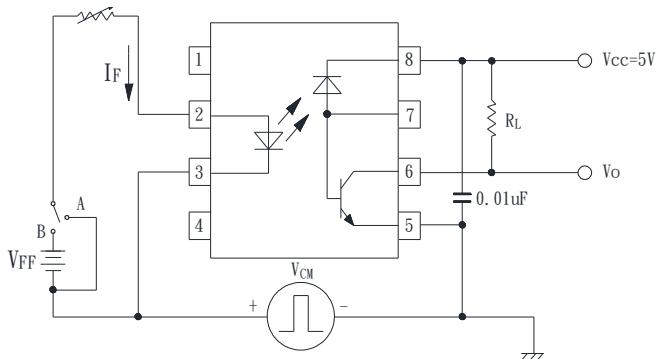
a common mode voltage variation that can hold the output above (0) level ( $V_o < 0.8\text{V}$ )

\*12 Bandwidth represents a point where AC input goes down by 3dB.

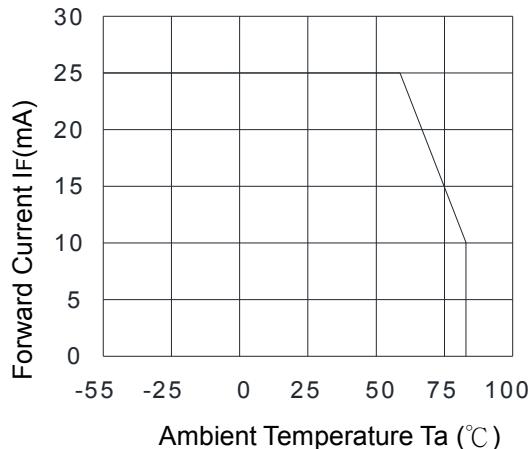
\*9 Test Circuit Propagation Delay Time



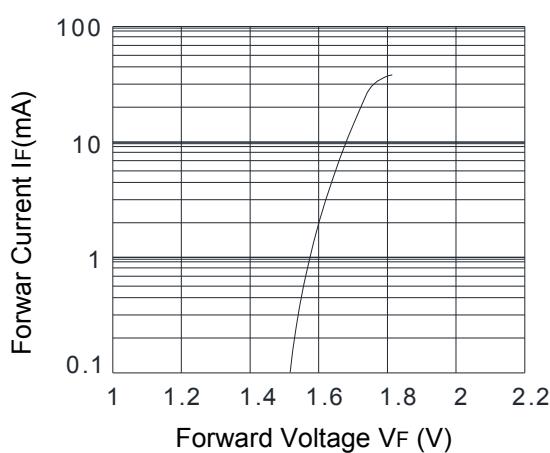
\*11 Test Circuit for Instantaneous Common Mode Rejection Voltage



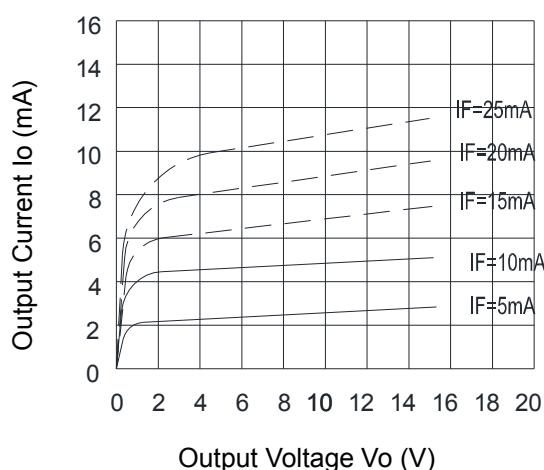
**Fig.1 Forward Current  
vs. Ambient Temperature**



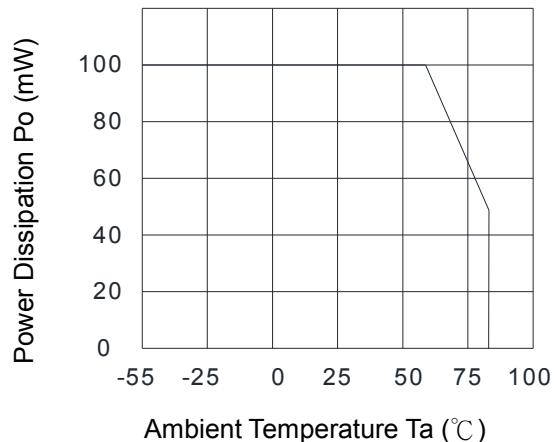
**Fig.3 Forward Current  
vs. Forward Voltage**



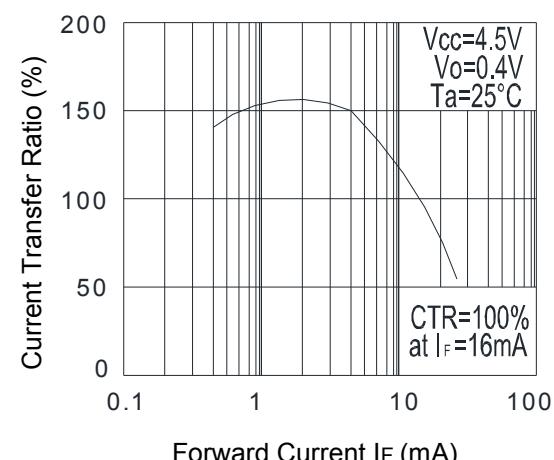
**Fig.5 Output Current  
vs. Output Voltage**



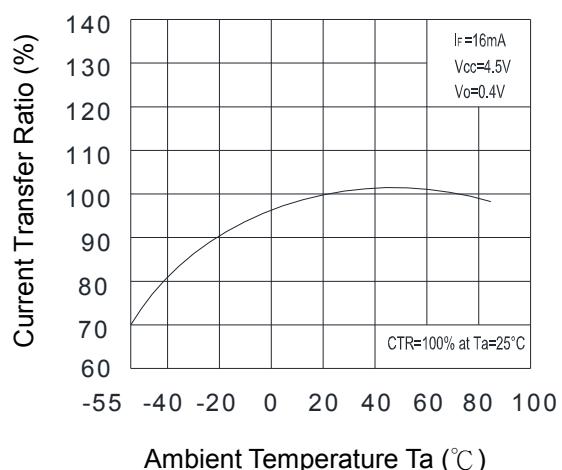
**Fig.2 Power Dissipation  
vs. Ambient Temperature**



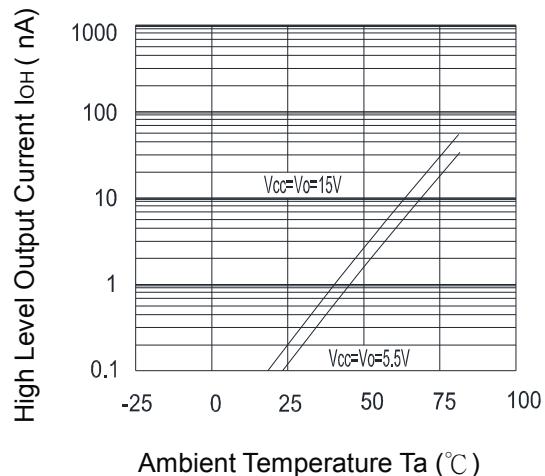
**Fig.4 Current Transfer Ratio  
vs. Forward Current**



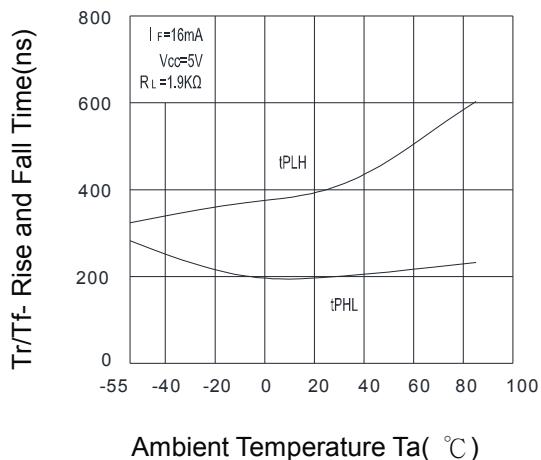
**Fig.6 Current Transfer Ratio  
vs. Ambient Temperature**



**Fig.7 High Level Output Current  
vs. Ambient Temperature**



**Fig.8 Propagation Delay Time  
vs. Ambient Temperature**

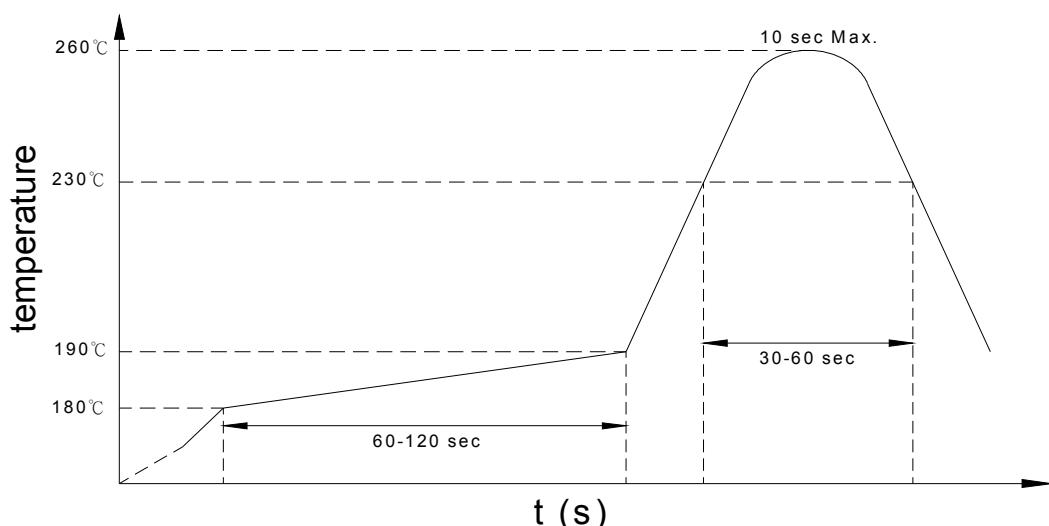


- Recommended Soldering Conditions

- (a) Infrared reflow soldering :

- |  |  |
|--|--|
| ■ Peak reflow soldering :                      | 260°C or below (package surface temperature)   |
| ■ Time of peak reflow temperature :            | 10 sec   |
| ■ Time of temperature higher than 230°C :      | 30-60 sec  |
| ■ Time to preheat temperature from 180~190°C : | 60-120 sec   |
| ■ Time(s) of reflow :                          | Two  |
| ■ Flux :                                       | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

**Recommended Temperature Profile of Infrared Reflow**



- (b) Wave soldering :

- |                           |  |
|---------------------------|--|
| ■ Temperature :           | 260°C or below (molten solder temperature)   |
| ■ Time :                  | 10 seconds or less   |
| ■ Preheating conditions : | 120°C or below (package surface temperature)   |
| ■ Time(s) of reflow :     | One  |
| ■ Flux :                  | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

- (c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

- Numbering System

### **KPC6N136 X (Y)**

**Notes:**

KPC6N135 = Part No.

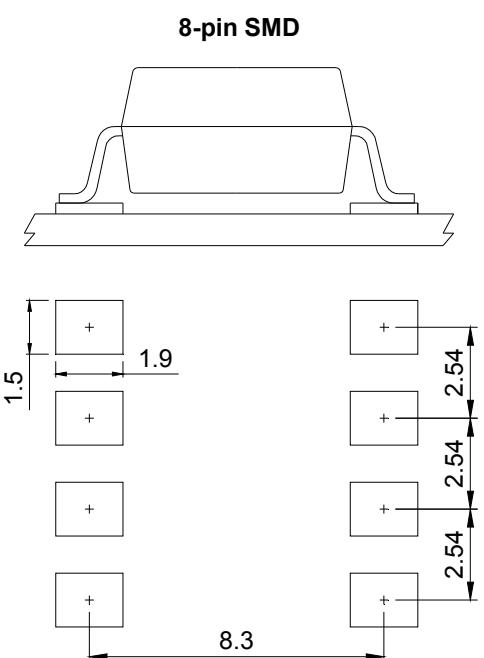
X = Lead form option (blank、S、H、L )

Y = Tape and reel option (TL、TR、TLD、TRU)

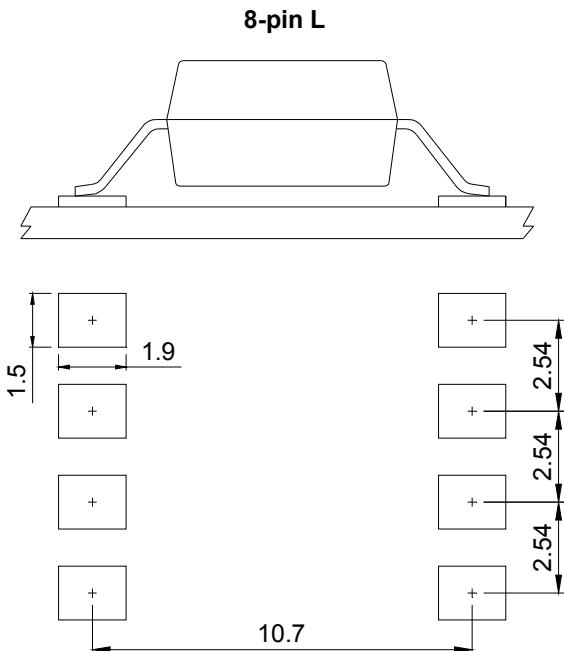
Option	Description	Packing quantity
S (TL)	surface mount type package + TL tape & reel option	1000 units per reel
S (TR)	surface mount type package + TR tape & reel option	1000 units per reel
L (TLD)	long creepage distance for surface mount type package + TLD tape & reel option	800 units per reel
L (TRU)	long creepage distance for surface mount type package + TRU tape & reel option	800 units per reel

- Recommended Pad Layout for Surface Mount Lead Form

**1.Surface mount type**

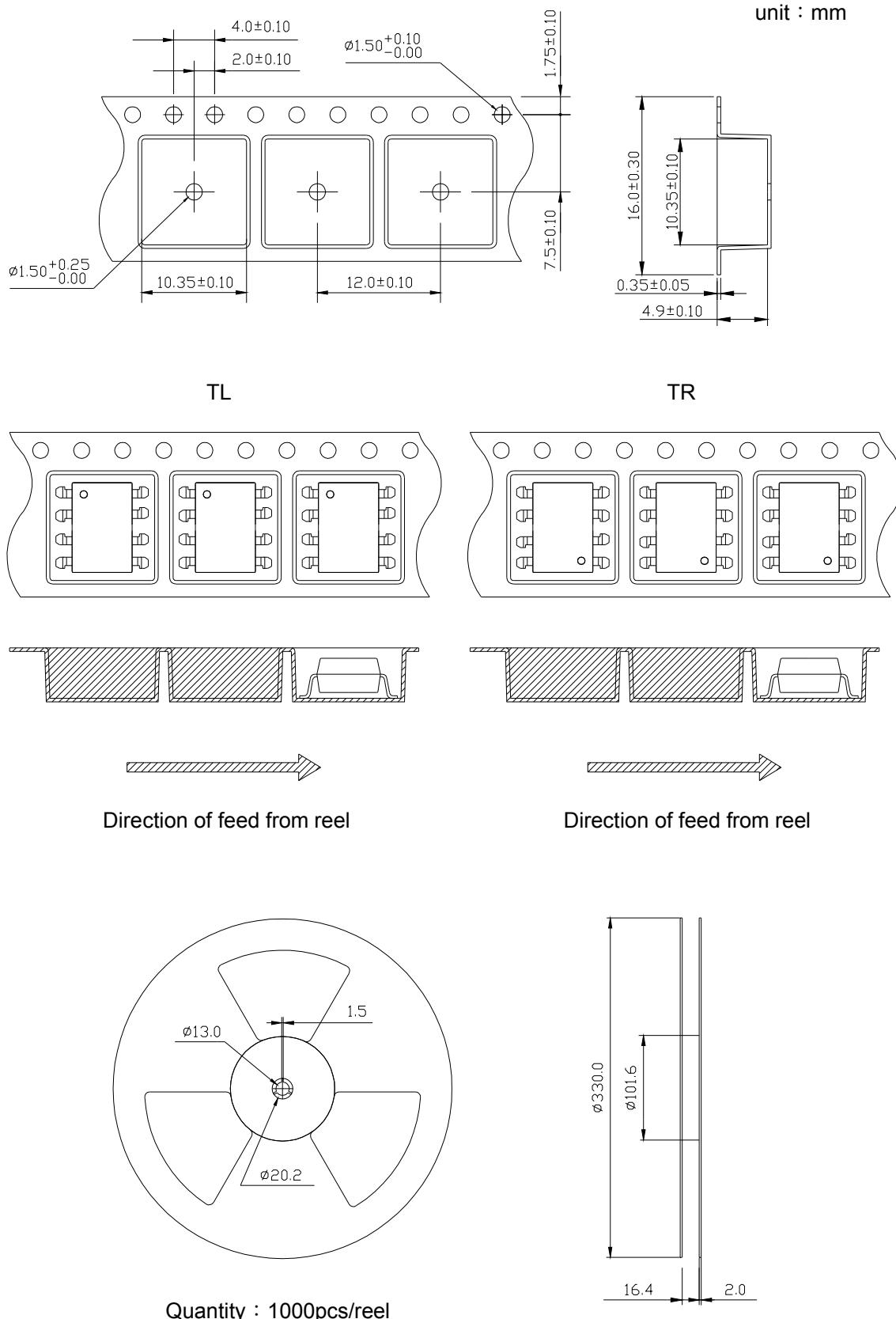


**2.Long creepage distance  
for surface mount type**



Unit :mm

- 8-pin SMD Carrier Tape & Reel

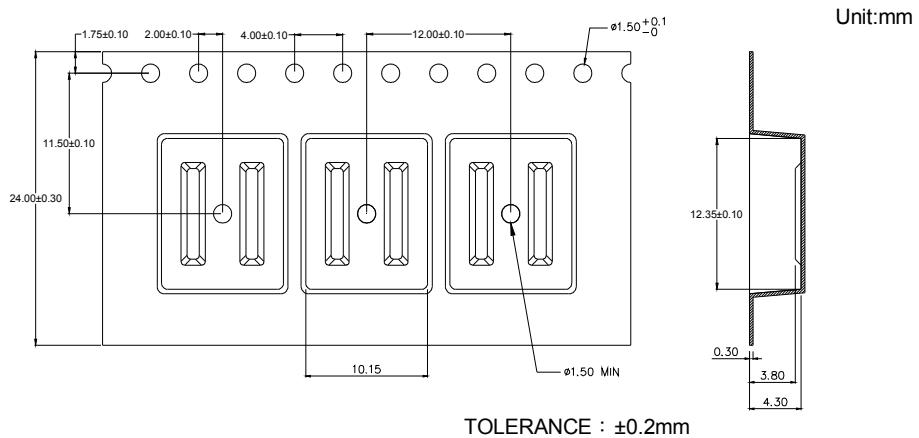




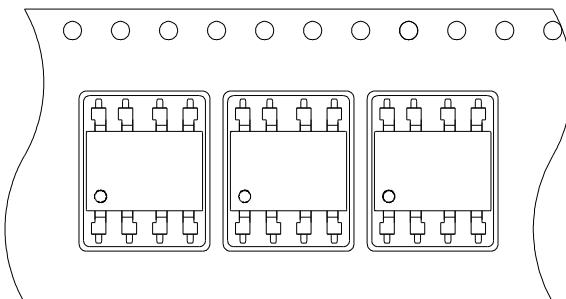
# KPC6N136 Series

## 8PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

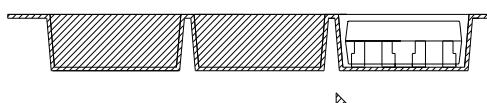
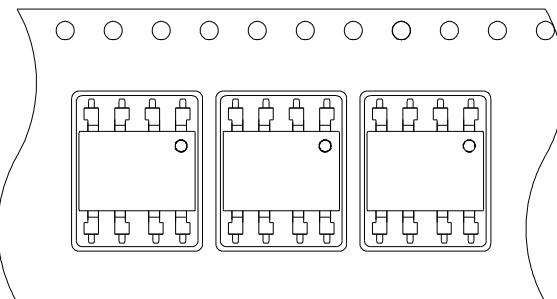
- 8-pin L Carrier Tape & Reel



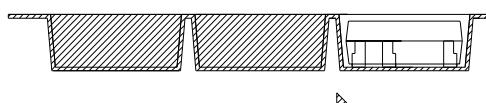
TLD



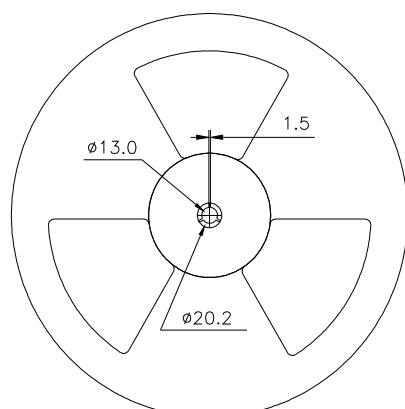
TRU



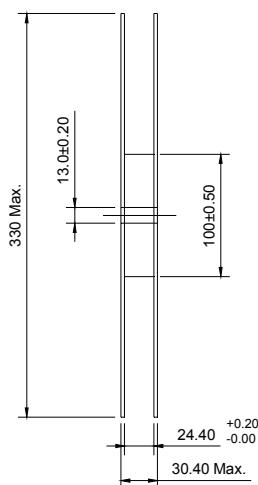
Direction of feed from reel



Direction of feed from reel



Quantity : 800pcs/reel





# KPC6N136 Series

## 8PIN HIGH-SPEED OUTPUT PHOTOCOUPLER

### ● Application Notice

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- c. Audio / Video
- d. Instrumentation
- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

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- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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